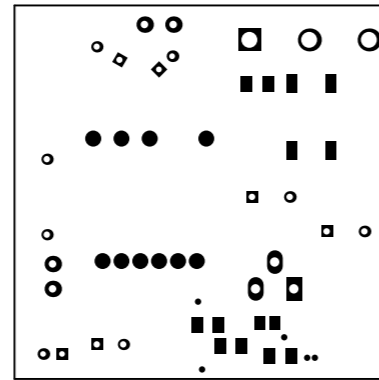
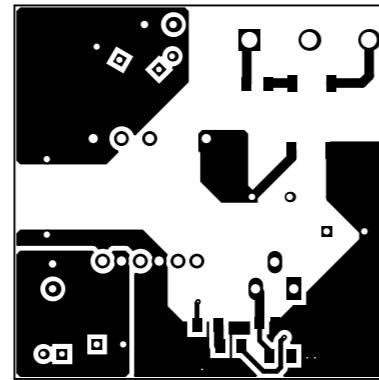


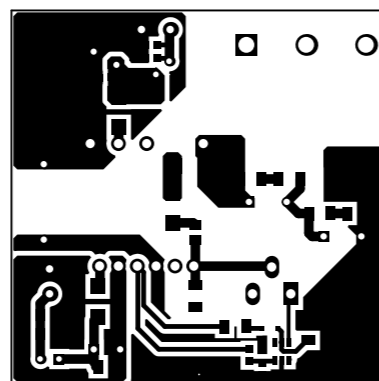
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10397	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 9/21/2014 11:46:45 PM	TEXAS INSTRUMENTS	



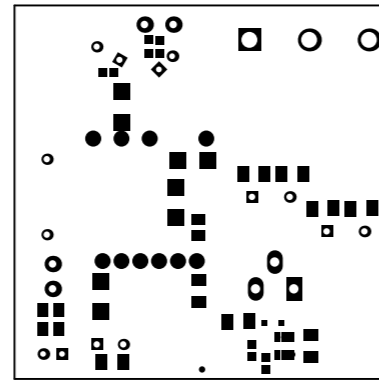
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LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 9/21/2014 11:46:46 PM	TEXAS INSTRUMENTS	



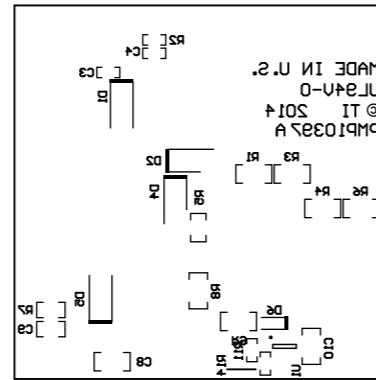
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LAYER NAME = Top Layer			
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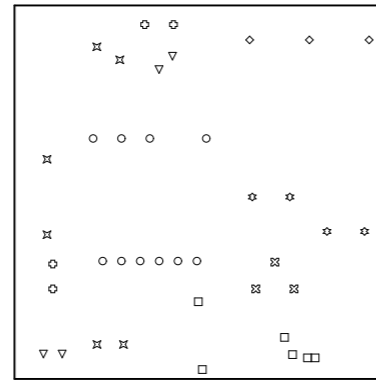
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LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 9/21/2014 11:46:47 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10397	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 9/21/2014 11:46:47 PM	TEXAS INSTRUMENTS	



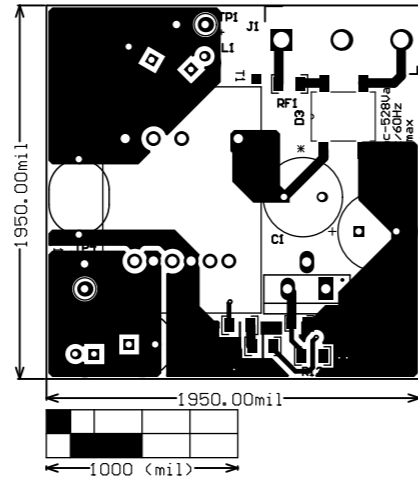
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10397	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 9/21/2014 11:46:48 PM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
□	6	10mil (0.254mm)	PTH	Round
▽	4	31mil (0.787mm)	PTH	Round
×	6	33.465mil (0.85mm)	PTH	Round
*	4	35mil (0.889mm)	PTH	Round
⊙	4	40mil (1.016mm)	PTH	Round
○	10	49.213mil (1.25mm)	PTH	Round
⊗	3	50mil (1.27mm)	PTH	Round
◇	3	84.646mil (2.15mm)	PTH	Round
40 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10397	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 9/21/2014 11:46:48 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10397	REV: A	SUN REV: Not In VersionControl
LAYER NAME = MapBoardDimensions			
PLOT NAME = Board Dimensions	GENERATED : 9/21/2014 11:46:49 PM	TEXAS INSTRUMENTS	

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